

STX790A

Medium current, high performance, low voltage PNP transistor

Features

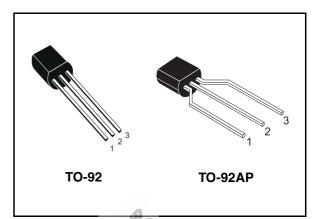
- Very low collector to emitter saturation voltage
- DC current gain, h_{FE} > 100
- 3 A continuous collector current
- 40 V breakdown voltage V_{(BR)CER}

Applications

- Power management in portable equipment
- Voltage regulation in bias supply circuits
- Switching regulator in battery charger applications
- Heavy load driver

Description

The device in manufactured in low voltage PNP planar technology by using a "Base Island" layout. The resulting transistor shows exceptional high gain performance coupled with very low saturation voltage.



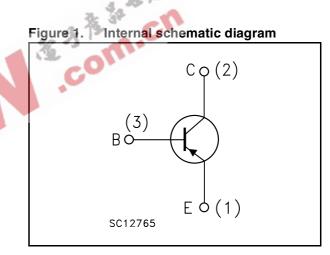


Table 1.	Device summary
	Borroo ourinnary

Order code	Marking	Package	Packaging
STX790A	X790A	TO-92	Bulk
STX790A-AP	X790A	TO-92 AP	Ammopack

June 2	800
--------	-----

Electrical ratings 1

Table 2.	Absolute maximum	rating
	Aboolato maximan	i a tini g

Symbol	Parameter	Value	Unit
V _{CBO}	Collector-base voltage (I _E = 0)	-40	V
V_{CER}	Collector-emitter voltage (R_{BE} = 47 Ω)	-40	V
V _{CEO}	Collector-emitter voltage (I _B = 0)	-30	V
V_{EBO}	Emitter-base voltage (I _C = 0)	-5	V
۱ _C	Collector current	-3	Α
I _{CM}	Collector peak current (t _P < 5 ms)	-6	Α
P _{tot}	Total dissipation at T _{amb} = 25 °C	0.9	W
T _{stg}	Storage temperature	-65 to 150	°C
ТJ	Max. operating junction temperature	150	°C
Table 3.	Thermal data		

Table 3. Thermal data

Symbol	Parameter	36 3 1	Value	Unit
R _{thj-case}	Thermal resistance junction-case	max	44.6	°C/W
R _{thj-amb}	Thermal resistance junction-amb	max	139	°C/W

2 Electrical characteristics

(T_{case} = 25 °C unless otherwise specified)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{CBO}	Collector cut-off current (I _E = 0)	V _{CB} = -30 V V _{CB} = -30 V; T _C = 100 °C			-10 -100	μA μA
I _{EBO}	Emitter cut-off current (I _C = 0)	V _{EB} = -4 V			-10	μA
V _{(BR)CEO} ⁽¹⁾	Collector-emitter breakdown voltage (I _B = 0)	I _C = -10 mA	-30			V
V _{(BR)CER} ⁽¹⁾	Collector-emitter breakdown voltage ($R_{BE} = 47 \Omega$)	I _C = -10 mA	-40			V
V _{(BR)CBO}	Collector-base breakdown voltage (I _E = 0)	I _C = -100 μA	-40			V
V _{(BR)EBO}	Emitter-base breakdown voltage (I _C = 0)	l _E = -100 μA	-5			V
		I _C = -0.5 A I _B = -5 mA			-0.15	V
		$I_{\rm C} = -1.2 \text{ A}$ $I_{\rm B} = -20 \text{ mA}$			-0.25	V
V _{CE(sat)} ⁽¹⁾	Collector-emitter	$I_{\rm C} = -2 \text{ A}$ $I_{\rm B} = -20 \text{ mA}$			-0.5	V
	saturation voltage	$I_{\rm C} = -3 \text{ A}$ $I_{\rm B} = -100 \text{ mA}$			-0.7	V
		$I_{C} = -3 \text{ A}$ $I_{B} = -100 \text{ mA}$ $T_{J} = 100 \text{ °C}$			-0.9	v
V _{BE(sat)} ⁽¹⁾	Base-emitter saturation voltage	I _C = -1A I _B = -10mA		-0.8	-1	V
$V_{BE(on)}^{(1)}$	Base-emitter on voltage	$I_{\rm C} = -1$ A $V_{\rm CE} = -2$ V		-0.8	-1	V
h _{FE} ⁽¹⁾		I _C = -10mA V _{CE} = -2V	100	200	400	
		I _C = -500mA V _{CE} = -2V	100	200	400	
	DC current gain	$I_{C} = -1A$ $V_{CE} = -2V$	100			
		$I_{C} = -2A$ $V_{CE} = -1V$	100	160		
		$I_{C} = -3A$ $V_{CE} = -1V$	90	130		

 Table 4.
 Electrical characteristics



57

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
f _t	Transition frequency	I_{C} = -50 mA V_{CE} = -5 V f = 50 MHz		100		MHz
	Resistive load					
t _d	Delay time	$I_{\rm C} = -3 {\rm A}$ $V_{\rm CC} = -20 {\rm V}$		180	220	ns
t _r	Rise time	I _{B1} = -I _{B2} = -60 mA		160	210	ns
t _s	Storage time	see Figure 8		250	300	ns
t _f	Fall time			80	100	ns

 Table 4.
 Electrical characteristics (continued)

1. Pulse duration = 300 μ s, duty cycle \leq 1.5%

2.1 Electrical characteristics (curves)

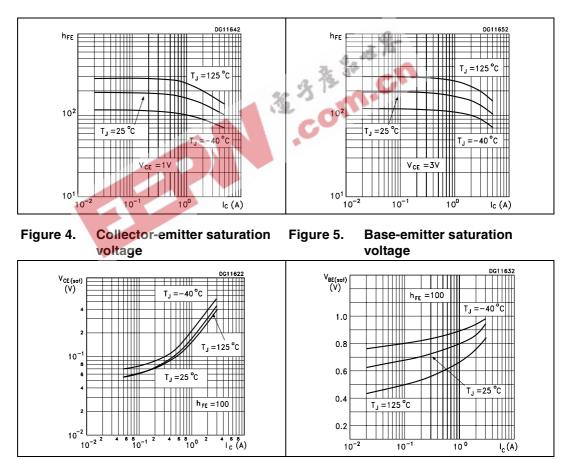


Figure 2. DC current gain

Figure 3. DC current gain

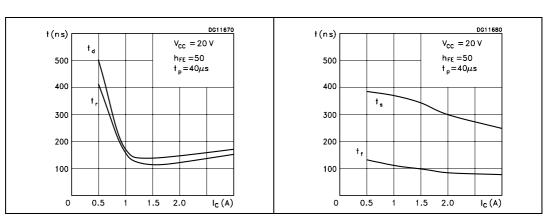
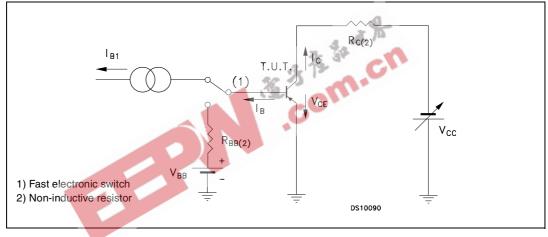


Figure 6. Switching time resistive load Figure 7. Switching time resistive load

2.2 Test circuit

Figure 8. Resistive load switching test circuit



57

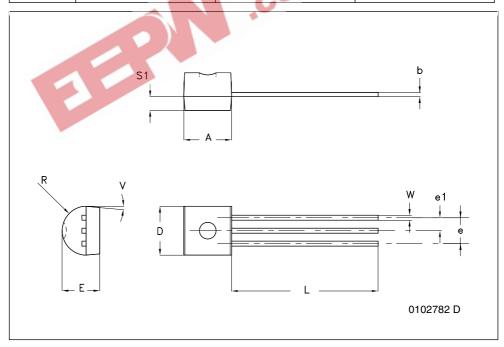
3 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com

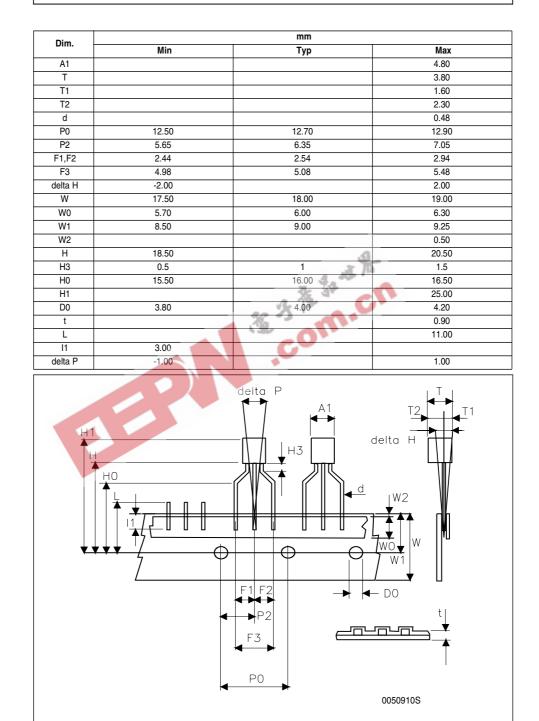




	TO-92 bulk shipment mechanical data				
DIM.		mm.			
DIWI.	MIN.	ТҮР	MAX.		
A	4.32		4.95		
b	0.36		0.51		
D	4.45		4.95		
E	3.30		3.94		
е	2.41		2.67		
e1	1.14		1.40		
L	12.70	0	15.49		
R	2.16	A L	2.41		
S1	0.92	34 AF	1.52		
w	0.41	2 3	0.56		
V		59			







TO-92 ammopack shipment (suffix"-AP") mechanical data

4 Revision history

Table 5.Document revision history

Date	Revision	Changes
24-Mar-2003	1	Initial release.
29-Mar-2006	2	New template.
25-Jun-2008	3	Updated TO-92 mechanical data.





Please Read Carefully:

Information in this document is provided solely in connection with ST products. STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, modifications or improvements, to this document, and the products and services described herein at any time, without notice.

All ST products are sold pursuant to ST's terms and conditions of sale.

Purchasers are solely responsible for the choice, selection and use of the ST products and services described herein, and ST assumes no liability whatsoever relating to the choice, selection or use of the ST products and services described herein.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted under this document. If any part of this document refers to any third party products or services it shall not be deemed a license grant by ST for the use of such third party products or services, or any intellectual property contained therein or considered as a warranty covering the use in any manner whatsoever of such third party products or services or any intellectual property contained therein.

UNLESS OTHERWISE SET FORTH IN ST'S TERMS AND CONDITIONS OF SALE ST DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY WITH RESPECT TO THE USE AND/OR SALE OF ST PRODUCTS INCLUDING WITHOUT LIMITATION IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION), OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.

UNLESS EXPRESSLY APPROVED IN WRITING BY AN AUTHORIZE REPRESENTATIVE OF ST, ST PRODUCTS ARE NOT DESIGNED, AUTHORIZED OR WARRANTED FOR USE IN MILITARY, AIR CRAFT, SPACE, LIFE SAVING, OR LIFE SUSTAINING APPLICATIONS, NOR IN PRODUCTS OR SYSTEMS, WHERE FAILURE OR MALFUNCTION MAY RESULT IN PERSONAL INJURY, DEATH, OR SEVERE PROPERTY OR ENVIRONMENTAL DAMAGE.

Resale of ST products with provisions different from the statements and/or technical features set forth in this document shall immediately void any warranty granted by ST for the ST product or service described herein and shall not create or extend in any manner whatsoever, any liability of ST.

ST and the ST logo are trademarks or registered trademarks of ST in various countries.

Information in this document supersedes and replaces all information previously supplied.

The ST logo is a registered trademark of STMicroelectronics. All other names are the property of their respective owners.

© 2008 STMicroelectronics - All rights reserved

STMicroelectronics group of companies

Australia - Belgium - Brazil - Canada - China - Czech Republic - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan -Malaysia - Malta - Morocco - Singapore - Spain - Sweden - Switzerland - United Kingdom - United States of America

www.st.com

10/10

